



PMEG4002EJ

40 V, 200 mA low VF Schottky barrier rectifier

2 October 2025

Product data sheet

1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD323F (SC-90) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: $I_{F(AV)} \leq 0.2 \text{ A}$
- Reverse voltage: $V_R \leq 40 \text{ V}$
- Low forward voltage
- Small and flat lead SMD plastic package

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Ultra high-speed switching
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5; f = 20 \text{ kHz}; \text{square wave}; T_{\text{amb}} \leq 130 \text{ }^{\circ}\text{C}$	[1]	-	-	0.2	A
		$\delta = 0.5; f = 20 \text{ kHz}; \text{square wave}; T_{\text{sp}} \leq 145 \text{ }^{\circ}\text{C}$		-	-	0.2	A
V_R	reverse voltage	$T_j = 25 \text{ }^{\circ}\text{C}$		-	-	40	V
V_F	forward voltage	$I_F = 200 \text{ mA}; T_j = 25 \text{ }^{\circ}\text{C}$		-	520	600	mV
I_R	reverse current	$V_R = 40 \text{ V}; T_j = 25 \text{ }^{\circ}\text{C}$		-	0.7	10	μA

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 SC-90 (SOD323F)	
2	A	anode		

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6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG4002EJ	SC-90	plastic, surface-mounted package; 2 leads; 1.7 mm x 1.25 mm x 0.7 mm body	SOD323F

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG4002EJ	1N

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	$T_j = 25 \text{ }^\circ\text{C}$		-	40	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; $f = 20 \text{ kHz}$; square wave; $T_{\text{amb}} \leq 130 \text{ }^\circ\text{C}$	[1]	-	0.2	A
		$\delta = 0.5$; $f = 20 \text{ kHz}$; square wave; $T_{\text{sp}} \leq 145 \text{ }^\circ\text{C}$		-	0.2	A
$I_{F\text{RM}}$	repetitive peak forward current	$t_p \leq 1 \text{ ms}$; $\delta \leq 0.25$		-	2.6	A
$I_{F\text{SM}}$	non-repetitive peak forward current	$t_p = 8 \text{ ms}$; square wave; $T_{j(\text{init})} = 25 \text{ }^\circ\text{C}$	[2]	-	2.75	A
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25 \text{ }^\circ\text{C}$	[2] [3]	-	385	mW
			[2] [4]	-	695	mW
			[1] [2]	-	1.045	W
T_j	junction temperature			-	150	$^\circ\text{C}$
T_{amb}	ambient temperature			-55	150	$^\circ\text{C}$
T_{stg}	storage temperature			-65	150	$^\circ\text{C}$

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2 .

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2] [3]	-	-	325	K/W
			[1] [2] [4]	-	-	180	K/W
			[1] [2] [5]	-	-	120	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[6]	-	-	25	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
 [2] Reflow soldering is the only recommended soldering method.
 [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
 [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
 [5] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
 [6] Soldering point of cathode tab.

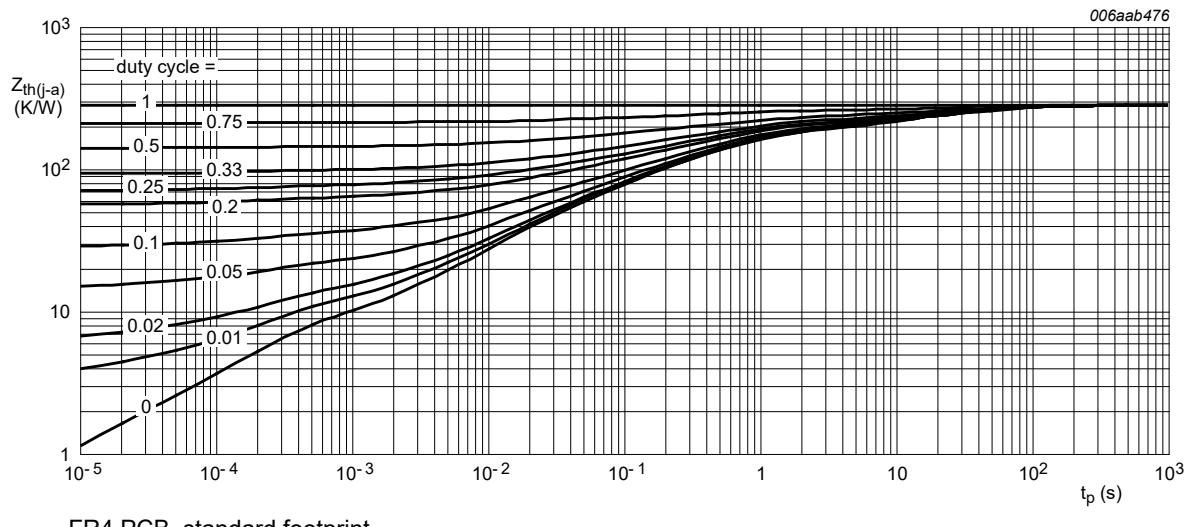


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

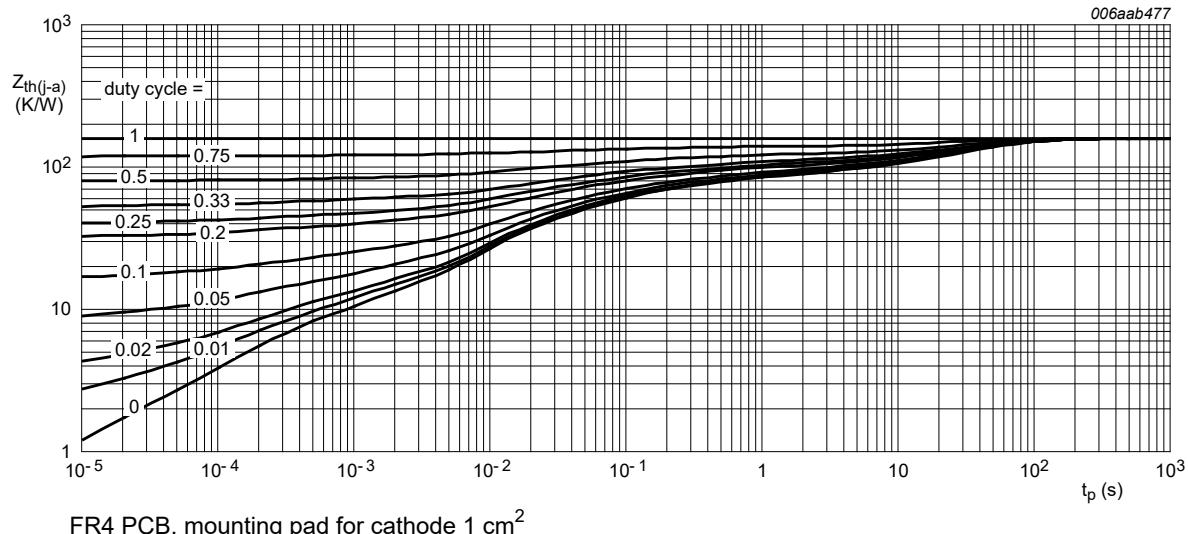


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

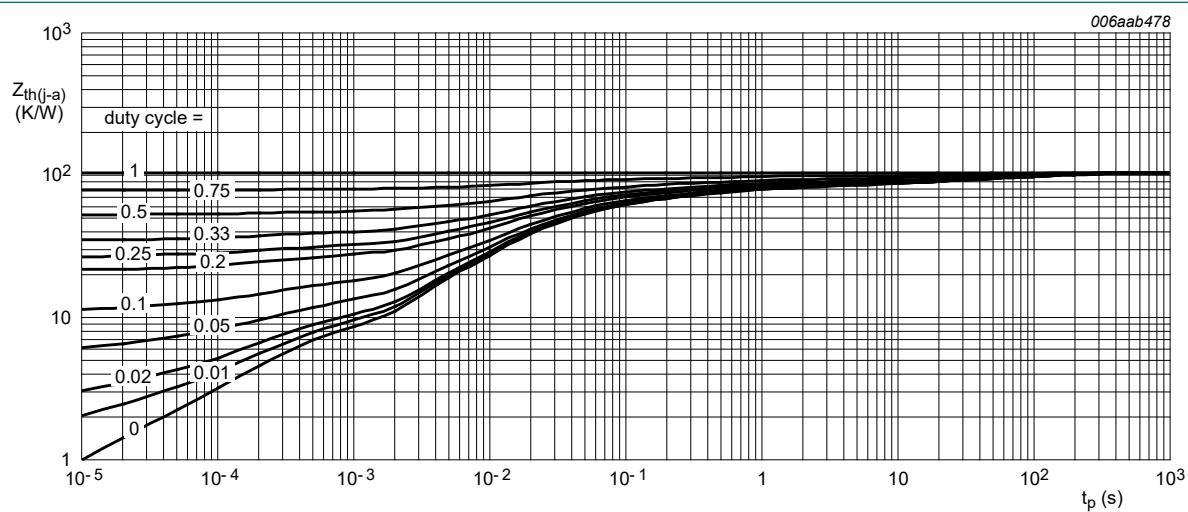


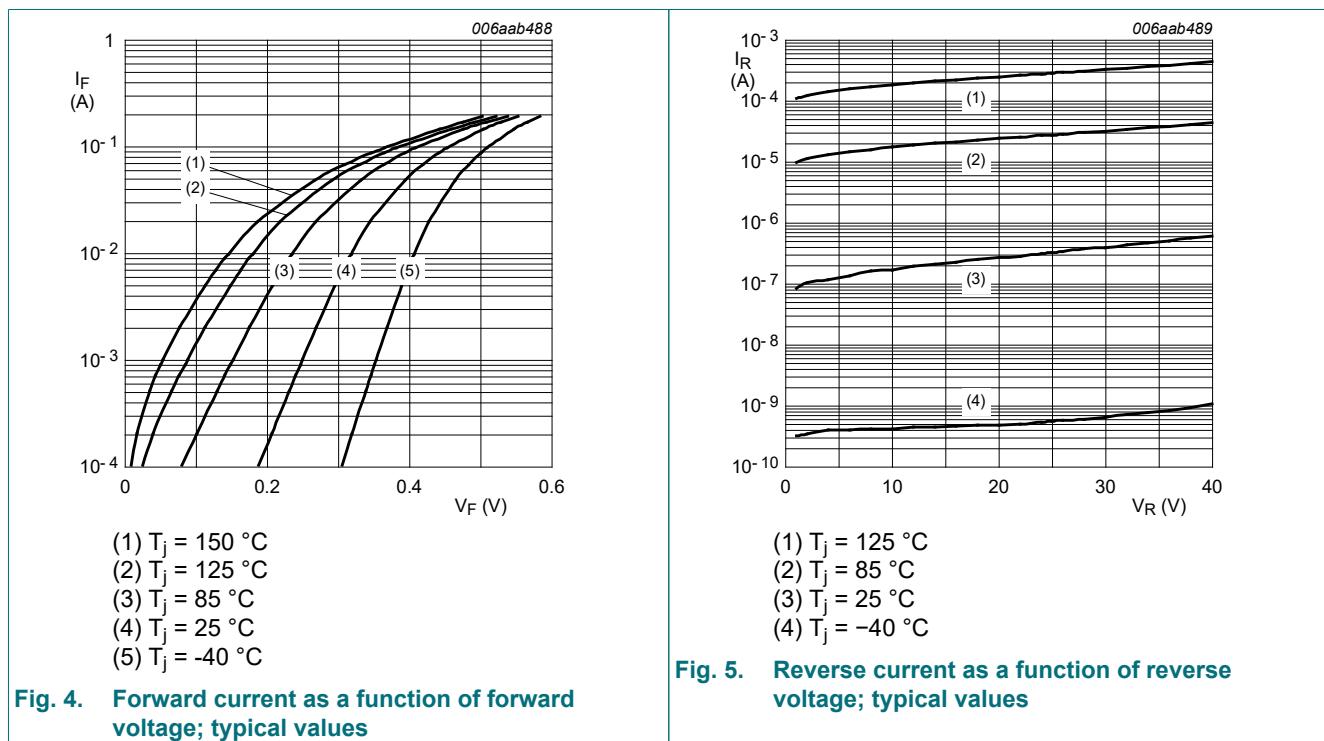
Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

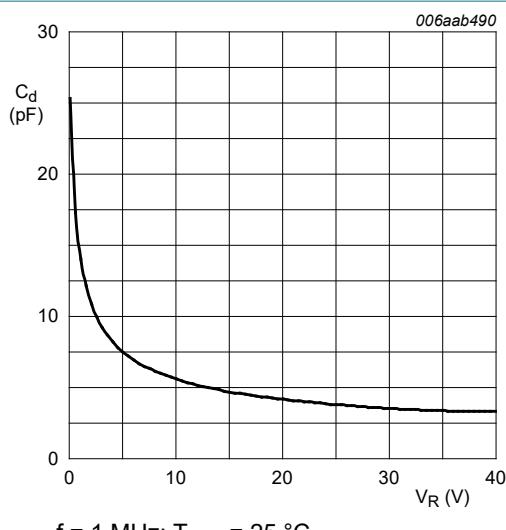
10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	[1]	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 0.1 \text{ mA}; T_j = 25^\circ\text{C}$	[1]	-	190	220	mV
		$I_F = 1 \text{ mA}; T_j = 25^\circ\text{C}$		-	250	290	mV
		$I_F = 10 \text{ mA}; T_j = 25^\circ\text{C}$		-	320	360	mV
		$I_F = 100 \text{ mA}; T_j = 25^\circ\text{C}$		-	440	500	mV
		$I_F = 200 \text{ mA}; T_j = 25^\circ\text{C}$		-	520	600	mV
I_R	reverse current	$V_R = 10 \text{ V}; T_j = 25^\circ\text{C}$		-	0.2	0.3	μA
		$V_R = 25 \text{ V}; T_j = 25^\circ\text{C}$		-	0.3	0.5	μA
		$V_R = 40 \text{ V}; T_j = 25^\circ\text{C}$		-	0.7	10	μA
C_d	diode capacitance	$V_R = 1 \text{ V}; f = 1 \text{ MHz}; T_j = 25^\circ\text{C}$		-	14	-	pF
		$V_R = 10 \text{ V}; f = 1 \text{ MHz}; T_j = 25^\circ\text{C}$		-	6	-	pF
t_{rr}	reverse recovery time	when switched from $I_{asub>F} = 10 \text{ mA}$ to $I_R = 10 \text{ mA}$; $R_L = 100 \text{ W}$; measured at $I_R = 1 \text{ mA}; T_j = 25^\circ\text{C}$		-	5	-	ns

[1]





$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$

Fig. 6. Diode capacitance as a function of reverse voltage; typical values

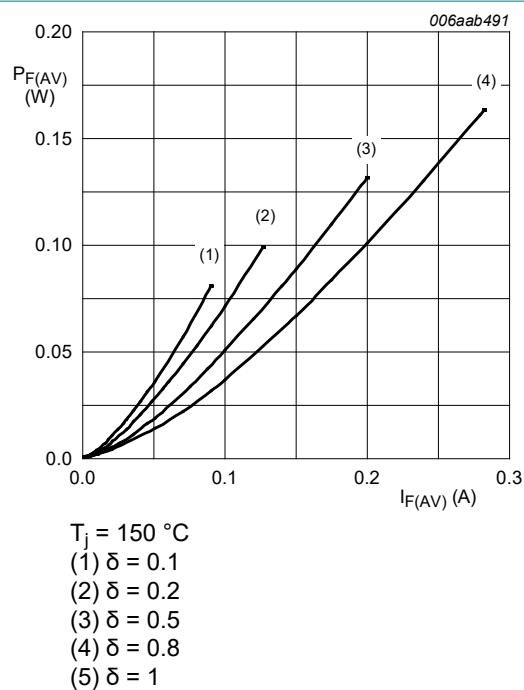


Fig. 7. Average forward power dissipation as a function of average forward current; typical values

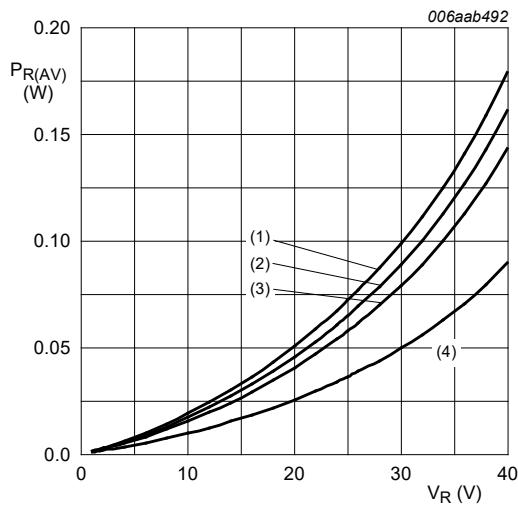


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values

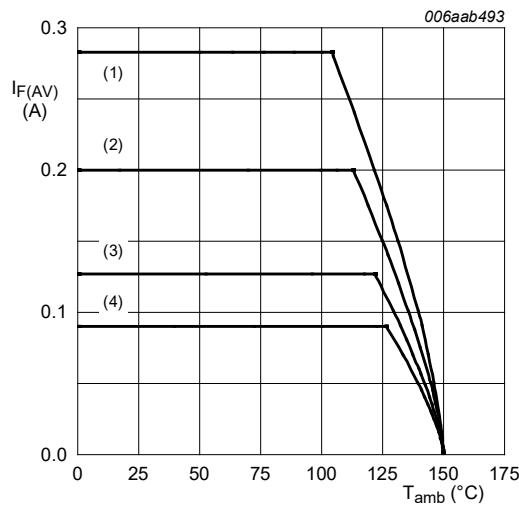
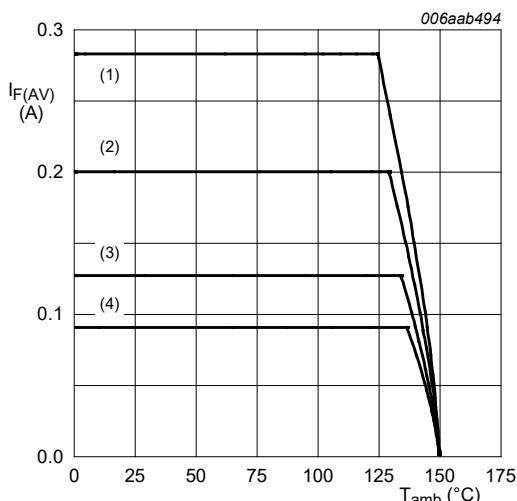


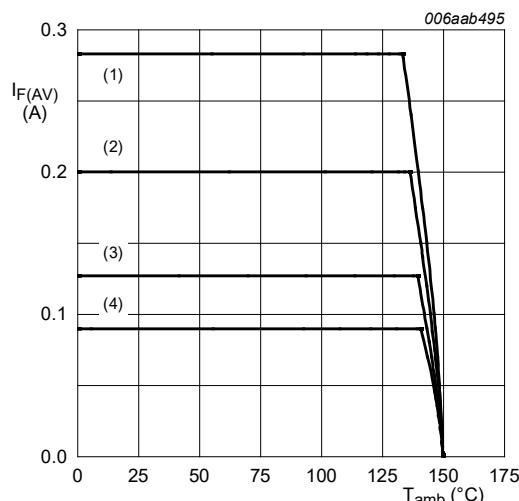
Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²
 $T_j = 150$ °C

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; $f = 20$ kHz
- (3) $\delta = 0.2$; $f = 20$ kHz
- (4) $\delta = 0.1$; $f = 20$ kHz

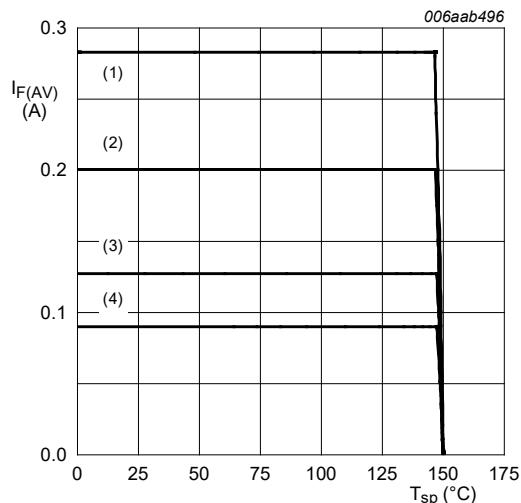
Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al_2O_3 , standard footprint
 $T_j = 150$ °C

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; $f = 20$ kHz
- (3) $\delta = 0.2$; $f = 20$ kHz
- (4) $\delta = 0.1$; $f = 20$ kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



$T_j = 150$ °C
(1) $\delta = 1$; DC
(2) $\delta = 0.5$; $f = 20$ kHz
(3) $\delta = 0.2$; $f = 20$ kHz
(4) $\delta = 0.1$; $f = 20$ kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

11. Test information

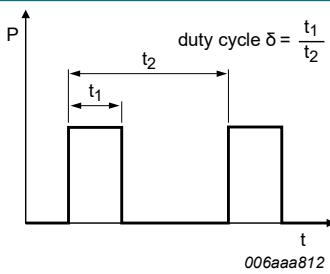
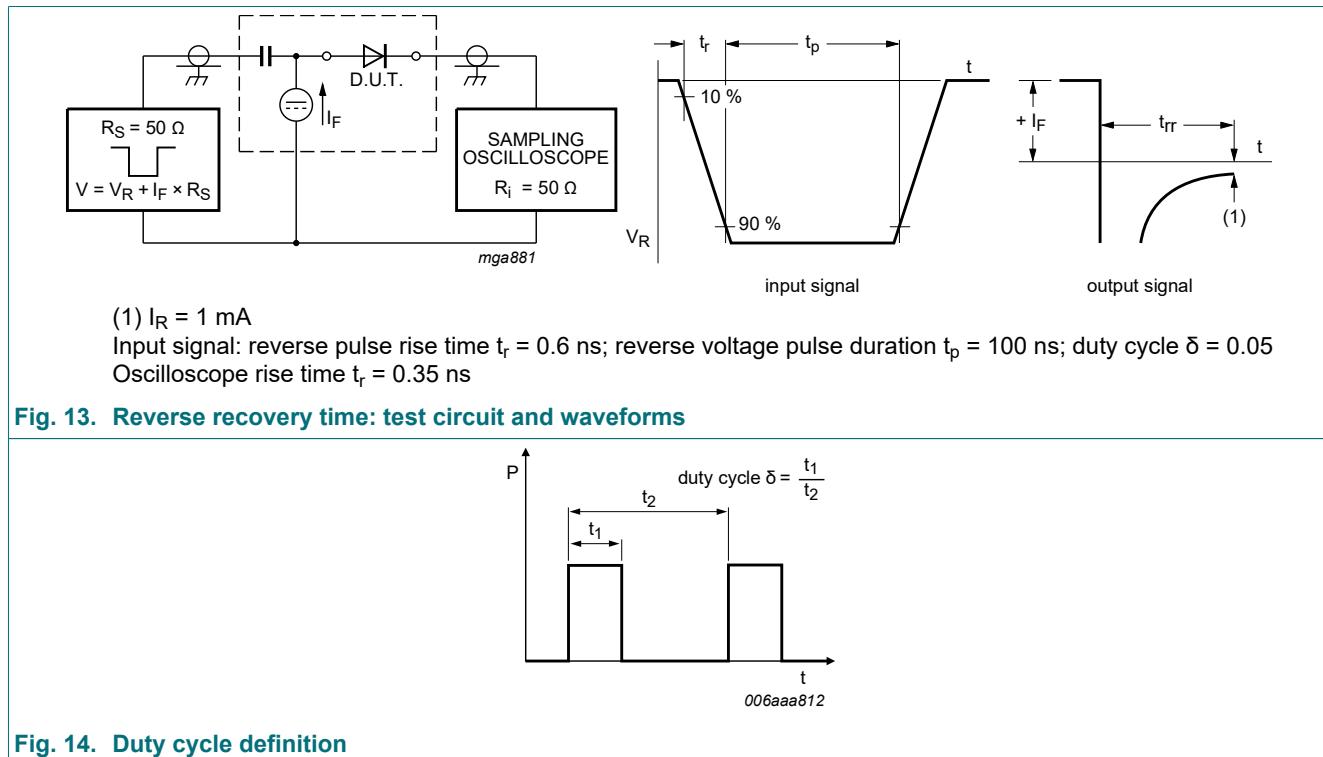


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta \text{ with } I_M \text{ defined as peak current}$$

$$I_{RMS} = I_{F(AV)} \text{ at DC}$$

$$I_{RMS} = I_M \times \sqrt{\delta} \text{ with } I_{RMS} \text{ defined as RMS current}$$

12. Package outline

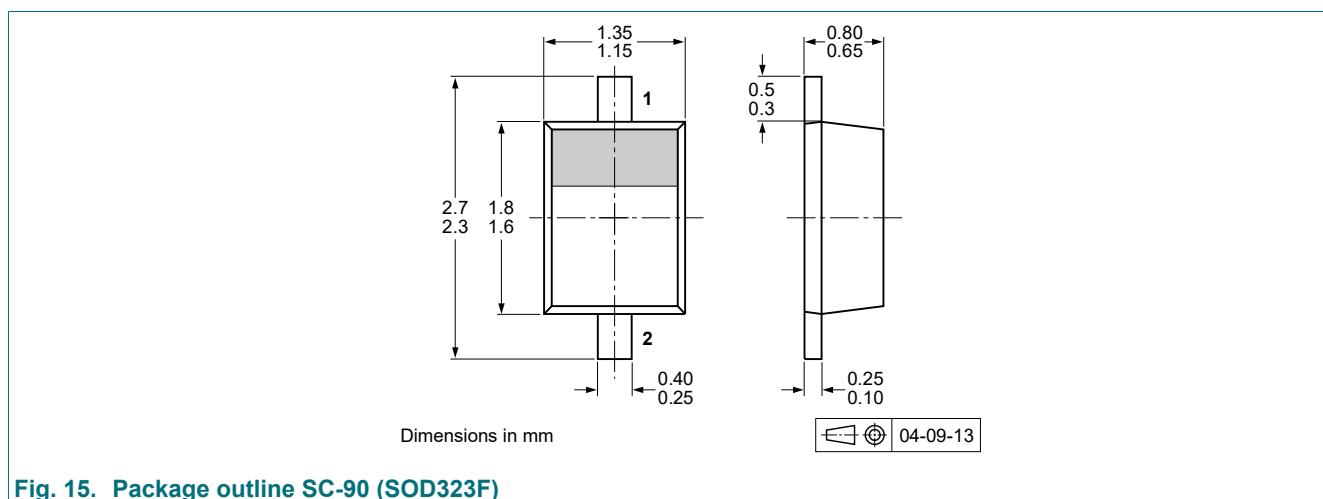
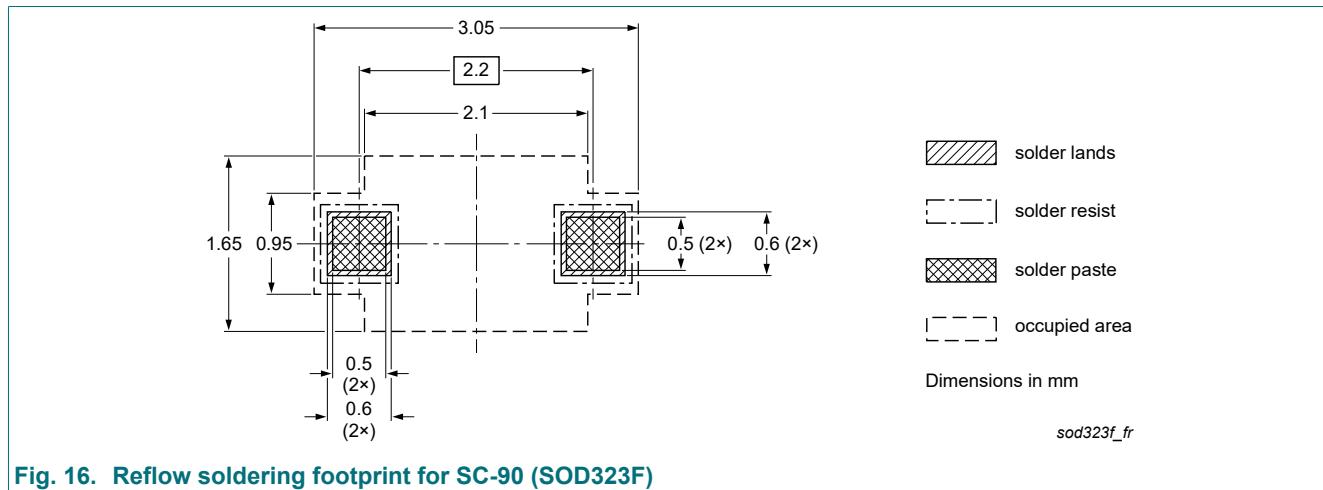


Fig. 15. Package outline SC-90 (SOD323F)

13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG4002EJ v.3	20251002	Product data sheet	-	PMEG4002EJ v.2
Modifications:	<ul style="list-style-type: none">Product(s) changed to non-automotive qualification. Please refer to nexperia.com for automotive (-Q) product alternative(s).			
PMEG4002EJ v.2	20230921	Product data sheet	-	PMEG4002EJ_1
PMEG4002EJ_1	20090515	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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